


Helping Customers Innovate, Improve & Grow



Description

Vectron's VC-708 Crystal Oscillator is a quartz stabilized, low phase noise, differential output oscillator which is hermetically sealed in a 5x7 ceramic package.

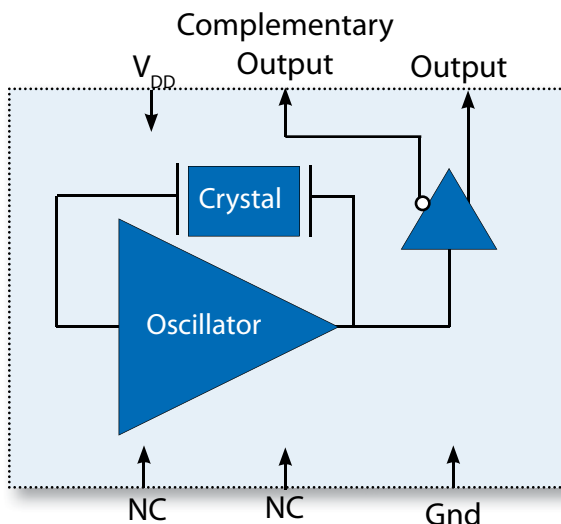
Features

- 47 fs RMS jitter typical, 12kHz-20MHz
- Ultra Low Jitter Performance, 3rd OT Crystal Design
- Differential Output
- Low Current Consumption
- -10/70°C or -40/85°C Operation
- Hermetically Sealed 5x7 Ceramic Package
- Product is compliant to RoHS directive  and fully compatible with lead free assembly

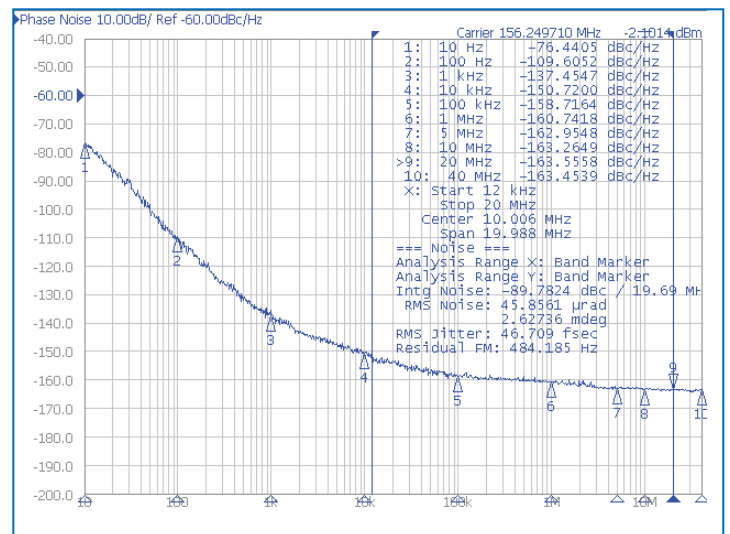
Applications

- Ethernet, GbE, SynchronE
- Fiber Channel
- PON
- Driving A/D's, D/A's, FPGA's
- Test and Measurement
- Medical
- Storage Area Networking
- Telecom
- COTS

Block Diagram



Phase Noise Plot



Performance Specifications

Table 1. Electrical Performance, LVPECL

Parameter	Symbol	Min	Typical	Maximum	Units
Supply					
Voltage ¹	V_{DD}	3.135 2.375	3.3 2.5	3.465 2.625	V V
Current (No Load)	I_{DD}		50	65	mA
Frequency					
Nominal Frequency	f_N	See Table 8.			MHz
Stability ² (Ordering Option)		±25, ±50, ±100			ppm
Outputs					
Output Logic Levels, -10/70°C					
Output Logic High	V_{OH}	$V_{DD}-1.025$		$V_{DD}-0.880$	V
Output Logic Low	V_{OL}	$V_{DD}-1.810$		$V_{DD}-1.620$	V
Output Logic Levels, -40/85°C					
Output Logic High	V_{OH}	$V_{DD}-1.085$		$V_{DD}-0.880$	V
Output Logic Low	V_{OL}	$V_{DD}-1.830$		$V_{DD}-1.555$	V
Output Rise and Fall Time ³					
Rise Time	t_R			1.0	ns
Fall Time	t_F			1.0	ns
Load		50 ohms into $V_{DD}-1.3V$			
Duty Cycle ⁴		45	50	55	%
Jitter, 156M250 ⁵	ϕ_J				
12 kHz - 20 MHz			47	100	fs
12 kHz - 40 MHz			75	150	fs
10 kHz -1 MHz			20	40	fs
1 kHz -1 MHz			90	180	fs
1.875 MHz-20 MHz			45	90	fs
Period Jitter ⁶	ϕ_J				
RMS			1.3		ps
P/P			12		ps
Deterministic Jitter ⁷			0		ps
Start-Up Time	t_{SU}			10	ms
Operating Temperature (Ordering Option)	T_{OP}	-10/70 or -40/85			°C
Package Size		5.0 x 7.0 x 1.8			mm

1. The VC-708 power supply pin should be filtered, e.g., a 10, 0.1, 0.01 and 0.001uf capacitors.
2. Includes calibration tolerance, operating temperature, supply voltage variations, aging and IR reflow.
3. Figure 1 defines these parameters.
4. Duty Cycle is defined as the On Time/Period, see Figure 1.
5. Measured using an Agilent E5052.
6. Measured using a LeCroy Wavemaster 8600A, 90K samples, no filtering applied.
7. Measured using a Wavecrest SIA3300C, 90K samples.

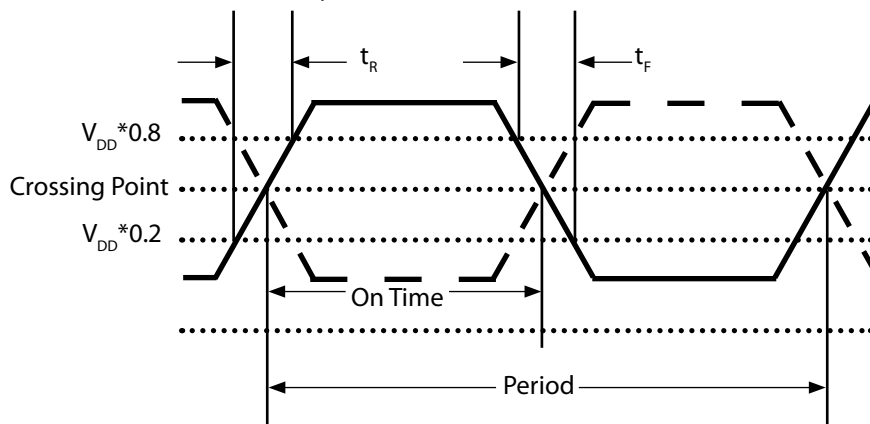


Figure 1.

Performance Specifications

Table 2. Electrical Performance, LVDS					
Parameter	Symbol	Min	Typical	Maximum	Units
Supply					
Voltage ¹ (Ordering Option)	V_{DD}	3.135 2.375	3.3 2.5	3.465 2.625	V V
Current (No Load)	I_{DD}		37	48	mA
Frequency					
Nominal Frequency	f_N	See Table 9.			MHz
Stability ² (Ordering Option)		±25, ±50, ±100			ppm
Outputs					
Differential Output Amplitude		247		454	mV
Differential Output Error		-50		50	mV
Offset Voltage		1.125	1.250	1.375	V
Offset Voltage Error		-50		50	mV
Output Rise and Fall Time ³					
Rise Time	t_R			1.0	ns
Fall Time	t_F			1.0	ns
Load		100 ohms differential			
Duty Cycle ^{3,4}		45	50	55	%
Jitter 156.250MHz ⁵	ϕ_J				
12 kHz - 20 MHz			65	130	fs
12 kHz - 40 MHz			90	180	fs
10 kHz - 1 MHz			35	70	fs
1 kHz - 1 MHz			90	180	fs
1.875 MHz-20 MHz			63	120	fs
Period Jitter ⁶	ϕ_J				
RMS			1.3		ps
P/P			12		ps
Deterministic Jitter ⁷			0		ps
Start-Up Time	t_{SU}			10	ms
Operating Temperature (Ordering Option)	T_{OP}	-10/70 or -40/85			°C
Package Size		5.0 x 7.0 x 1.8			mm

1. The VC-708 power supply pin should be filtered, eg, a 10, 0.1, 0.01, 0.001uf capacitors.
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3. Figure 1 defines these parameters.
4. Duty Cycle is defined as the On Time/Period, see Figure1.
5. Measured using an Agilent E5052.
6. Measured using a LeCroy Wavemaster 8600A, 90K samples, no filtering applied.
7. Measured using a Wavecrest SIA3300C, 90K samples.

Package and Pinout

Table 3. Pinout

Pin #	Symbol	Function
1	NC	No Internal Connection is made
2	NC	No Internal Connection is made
3	GND	Electrical and Lid Ground
4	f_o	Output Frequency
5	Cf_o	Complementary Output Frequency
6	V_{DD}	Supply Voltage

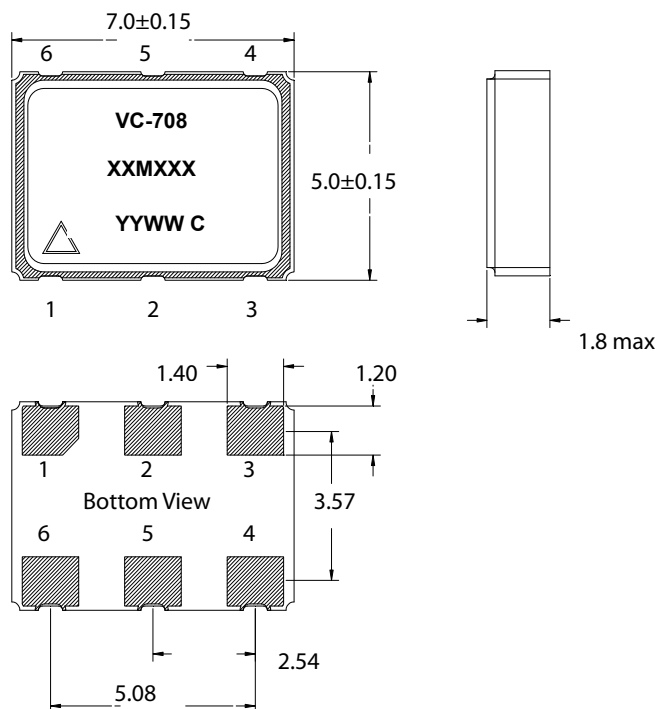
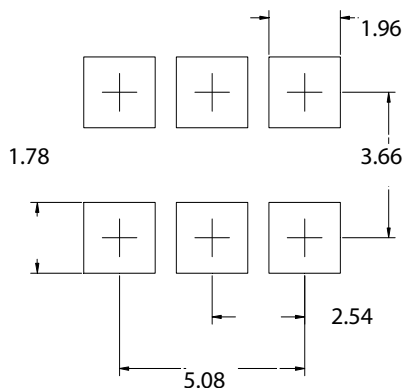


Figure 3. Package Outline Drawing



Units are mm

Figure 2. Pad Layout

LVPECL Application Diagrams

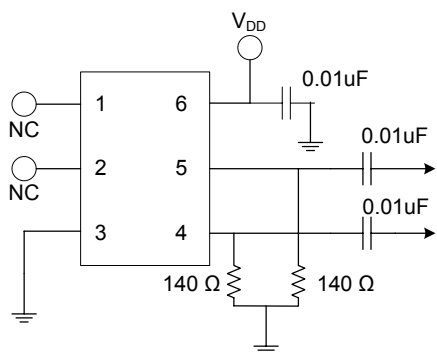


Figure 4. Single Resistor Termination Scheme

Resistor values are typically 140 ohms for 3.3V operation and 84 ohms for 2.5V operation.

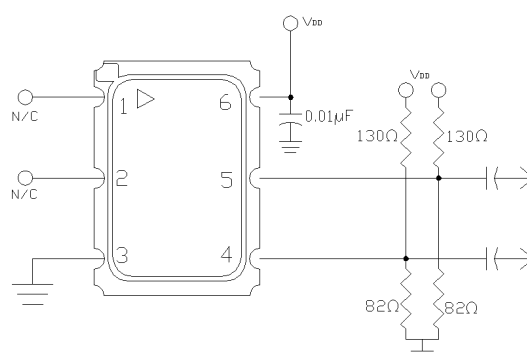


Figure 5. Pull-Up Pull Down Termination

Resistor values shown are typical for 3.3 V operation. For 2.5V operation, the resistor to ground is 62 ohms and the resistor to supply is 250 ohms

The VC-708 incorporates a standard PECL output scheme, which are unterminated FET drains. There are numerous application notes on terminating and interfacing PECL logic and the two most common methods are a single resistor to ground, Figure 4, and a pull-up/pull-down scheme as shown in Figure 5. AC coupling capacitor are optional, depending on the application and the input logic requirements of the next stage.

One of the most important considerations is terminating the Output and Complementary Outputs equally. An unused output should not be left unterminated, and if it one of the two outputs is left open it will result in excessive jitter on both. PC board layout must take this and 50 ohm impedance matching into account. Load matching and power supply noise are the main contributors to jitter related problems.

LVDS Application Diagrams

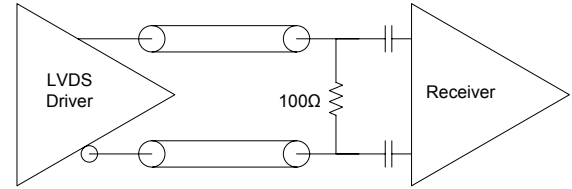
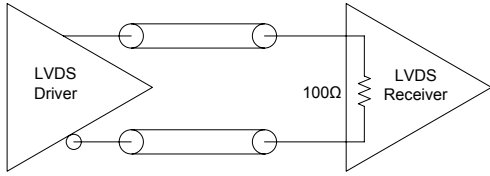


Figure 6. LVDS to LVDS Connection, Internal 100ohm Resistor
Some LVDS structures have an internal 100 ohm resistor on the input and do not need additional components. AC blocking capacitors can be used if the DC levels are incompatible.

Figure 7. LVDS to LVDS Connection
Some input structures may not have an internal 100 ohm resistor on the input and will need an external 100ohm resistor for impedance matching. Also, the input may have an internal DC bias which may not be compatible with LVDS levels, AC blocking capacitors can be used.

One of the most important considerations is terminating the Output and Complementary Outputs equally. An unused output should not be left un-terminated, and if it one of the two outputs is left open it will result in excessive jitter on both. PC board layout must take this and 50 ohm impedance matching into account. Load matching and power supply noise are the main contributors to jitter related problems.

Environmental and IR Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002
Mechanical Vibration	MIL-STD-883 Method 2007
Temperature Cycle	MIL-STD-883 Method 1010
Solderability	MIL-STD-883 Method 2003
Fine and Gross Leak	MIL-STD-883 Method 1014
Resistance to Solvents	MIL-STD-883 Method 2015
Moisture Sensitivity Level	MSL1
Contact Pads	Gold over Nickel Gold thickness is 0.3-1.0um

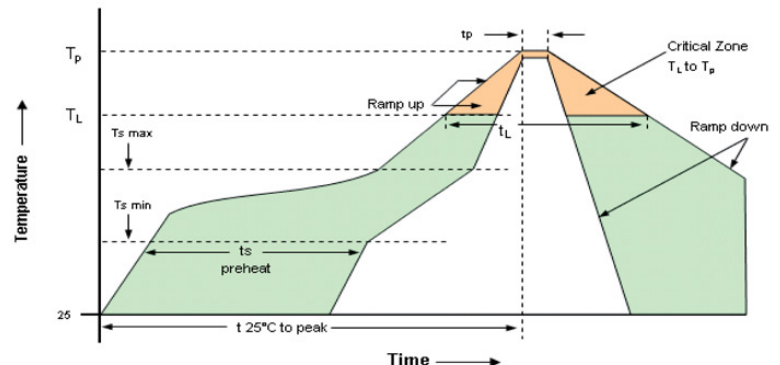
IR Compliance

Suggested IR Profile

Devices are built using lead free epoxy and can be subjected to standard lead free IR reflow conditions shown in Table 5. Contact pads are gold over nickel and lower maximum temperatures can also be used, such as 220C.

Parameter	Symbol	Value
PreHeat Time	t_s	200 sec Max
Ramp Up	R_{UP}	3°C/sec Max
Time above 217°C	t_L	150 sec Max
Time to Peak Temperature	t_{AMB-P}	480 sec Max
Time at 260°C	t_P	30 sec Max
Time at 240°C	t_{P2}	60 sec Max
Ramp down	R_{DN}	6°C/sec Max

Solderprofile:



Maximum Ratings, Tape & Reel

Absolute Maximum Ratings and Handling Precautions

Stresses in excess of the absolute maximum ratings can permanently damage the device. Functional operation is not implied or any other excess of conditions represented in the operational sections of this data sheet. Exposure to absolute maximum ratings for extended periods may adversely affect device reliability.

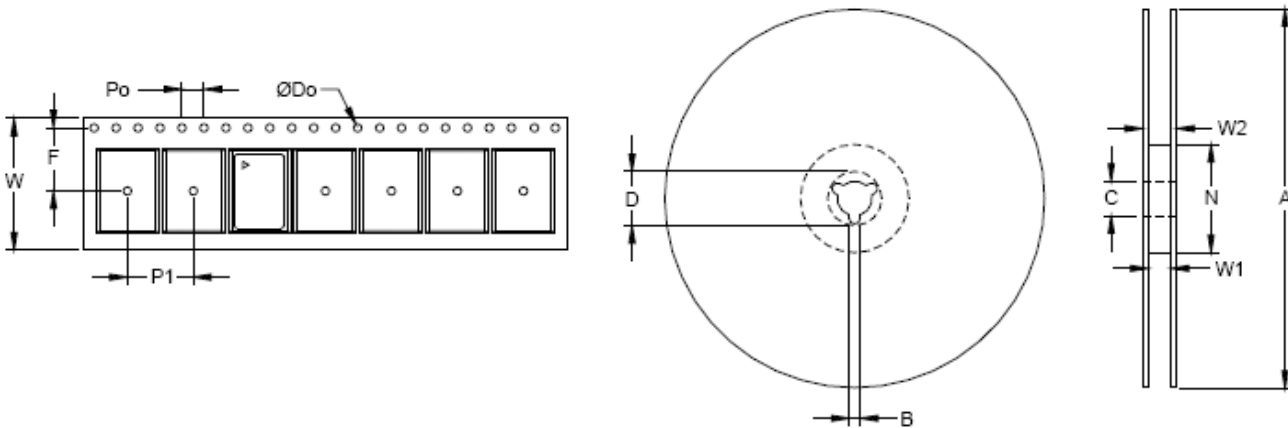
Although ESD protection circuitry has been designed into the VC-708, proper precautions should be taken when handling and mounting, VI employs a Human Body Model and Charged Device Model for ESD susceptibility testing and design evaluation.

ESD thresholds are dependent on the circuit parameters used to define the model. Although no industry standard has been adopted for the CDM a standard resistance of 1.5kOhms and capacitance of 100pF is widely used and therefor can be used for comparison purposes.

Parameter	Symbol	Rating	Unit
Storage Temperature	T_{STORE}	-50/125	°C
Supply Voltage		-0.5 to 7.0	V
ESD, Human Body Model		1500	V
ESD, Charged Device Model		1000	V

Table 7. Tape and Reel Information

Tape Dimensions (mm)					Reel Dimensions (mm)							
W	F	Do	Po	P1	A	B	C	D	N	W1	W2	#/Reel
16	7.5	1.5	4	8	180	2	13	21	55	17	21	250



Ordering Information

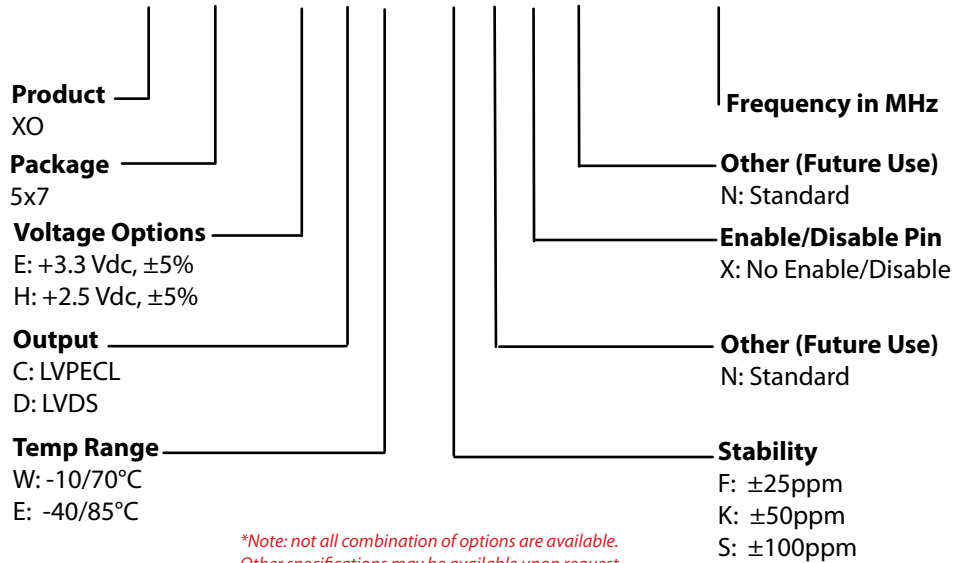
Table 8. Standard Output Frequencies (MHz) LVPECL

32.000	80.000	120.000	125.000	155.520	156.250	156.253906	156.257812
160.000	161.132800	161.132812	167.970	174.220	200.000		

Table 9. Standard Output Frequencies (MHz) LVDS

106M250	125M000	153M600	156M250	160M0000	161M1328	200M000	

VC-708- E C E - K N X N - 156M250000



Example: VC-708-ECE-KNXN-156M250000

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